

PCB D-SUB CONNECTORS

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✓ Active



TE CONNECTIVITY (TE) RCPT ASSY,LP,SHLD,RA50,STD CHAMP | CHAMP

6339447-7 TE Internal Number: 6339447-7

Always EU RoHS/ELV Compliant

Connector Style **Receptacle**

Centerline 2.16 mm [.085 in]

Number of Positions **50**

Number of Rows 2

Profile **Standard**

Product Drawings	RECEPTACLE ASSEMBLY, LOW PROFILE, SHIELDED, RIGHT ANGLE, 50 POSITION, BOARD LOCK, INTEGRAL LOCKING LATCH, CHAMP PDF English
CAD Files	3D PDF PDF 3D
	Customer View Model 2D_DXF.ZIP English
	Customer View Model 3D_IGS.ZIP English
	Customer View Model 3D_STP.ZIP English
Product Specifications	
Application Specification	CHAMP Printed Circuit (PC) Board Mounted Connectors PDF English
Product Environmental Compliance	
TE Material Declaration	MD_6339447-7_051520141450_dmtec ^{PDF} English

Please review product documents or **contact us** for the latest agency approval information. Please Note: Use the Product Drawing for all design activity.

	Profile	Standard
	PCB Mounting Orientation	Right Angle
	Applies To	Printed Circuit Board
	Grounded	Yes
	Orientation	Standard
	Product Type	Connector
	Shielded	Yes
	Shielded	163
Configuration Features	Number of Positions	50
	Number of Rows	2
	Preloaded	Yes
Body Features	Plating Material	Polyester
	Shield Plating Material	Nickel
	Color	Black
	Shield Plating Finish	Bright
	Shield Material	Copper-Zinc Alloy
Contact Features	Solder Tail Contact Plating Material	Tin
Contact Features	Solder Tail Contact Plating Material Contact Base Material	Tin Copper Alloy
Contact Features		
Contact Features	Contact Base Material	Copper Alloy
Contact Features	Contact Base Material Contact Mating Area Plating Thickness (µin)	Copper Alloy 30
	Contact Base Material Contact Mating Area Plating Thickness (µin) Contact Mating Area Plating Material	Copper Alloy 30 Gold
	Contact Base Material Contact Mating Area Plating Thickness (µin) Contact Mating Area Plating Material	Copper Alloy 30 Gold
Termination Features	Contact Base Material Contact Mating Area Plating Thickness (µin) Contact Mating Area Plating Material Termination Post Length	Copper Alloy 30 Gold 2.29 mm [.09 in]
Termination Features	Contact Base Material Contact Mating Area Plating Thickness (µin) Contact Mating Area Plating Material Termination Post Length PCB Mount Retention	Copper Alloy 30 Gold 2.29 mm [.09 in] With
Termination Features	Contact Base Material Contact Mating Area Plating Thickness (µin) Contact Mating Area Plating Material Termination Post Length PCB Mount Retention PCB Mount Retention Type	Copper Alloy 30 Gold 2.29 mm [.09 in] With Boardlocks
Termination Features	Contact Base Material Contact Mating Area Plating Thickness (µin) Contact Mating Area Plating Material Termination Post Length PCB Mount Retention PCB Mount Retention Type Mating Connector Lock	Copper Alloy 30 Gold 2.29 mm [.09 in] With Boardlocks With
Termination Features	Contact Base Material Contact Mating Area Plating Thickness (µin) Contact Mating Area Plating Material Termination Post Length PCB Mount Retention PCB Mount Retention Type Mating Connector Lock Mating Connector Lock Type	Copper Alloy 30 Gold 2.29 mm [.09 in] With Boardlocks With 4-40 Tapped Holes
Termination Features	Contact Base Material Contact Mating Area Plating Thickness (µin) Contact Mating Area Plating Material Termination Post Length PCB Mount Retention PCB Mount Retention Type Mating Connector Lock Mating Connector Lock Type Panel Mount Retention	Copper Alloy 30 Gold 2.29 mm [.09 in] With Boardlocks With 4-40 Tapped Holes Without
Termination Features Mechanical Attachment	Contact Base Material Contact Mating Area Plating Thickness (µin) Contact Mating Area Plating Material Contact Mating Area Plating Material Termination Post Length PCB Mount Retention PCB Mount Retention Type Mating Connector Lock Mating Connector Lock Type Panel Mount Retention Boardlock Material	Copper Alloy 30 Gold 2.29 mm [.09 in] With Boardlocks With 4-40 Tapped Holes Without Carbon Steel Tin
Termination Features	Contact Base Material Contact Mating Area Plating Thickness (µin) Contact Mating Area Plating Material Termination Post Length PCB Mount Retention PCB Mount Retention Type Mating Connector Lock Mating Connector Lock Type Panel Mount Retention Boardlock Material Boardlock Plating Material	Copper Alloy 30 Gold 2.29 mm [.09 in] With Boardlocks With 4-40 Tapped Holes Without Carbon Steel

Packaging Features	Packaging Method	Package	
	Packaging Quantity	40	
Other	Comb Material	Polyester	

Product Compliance

Statement of Compliance PDF

VIEW ALL PRODUCT COMPLIANCE